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| <b>INFORMATION DISCLOSURE<br/>STATEMENT BY APPLICANT</b><br>( Not for submission under 37 CFR 1.99) | Application Number     |                         | 10631898   |  |
|                                                                                                     | Filing Date            |                         | 2003-08-01 |  |
|                                                                                                     | First Named Inventor   | Philip Kwan             |            |  |
|                                                                                                     | Art Unit               | 2416                    |            |  |
|                                                                                                     | Examiner Name          | CHAN, Sai Ming          |            |  |
|                                                                                                     | Attorney Docket Number | FOUND-0057 (434103-048) |            |  |

| U.S.PATENTS       |         |               |                        |            |                                                 |                                                                          |
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|                   | 2       | 6981054       | B1                     | 2005-12-27 | Krishna                                         |                                                                          |
|                   | 3       | 7113479       | B2                     | 2006-09-26 | Wong, David                                     |                                                                          |
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